

MITSUBISHI IGBT MODULES
CM300DU-34KA

HIGH POWER SWITCHING USE

CM300DU-34KA



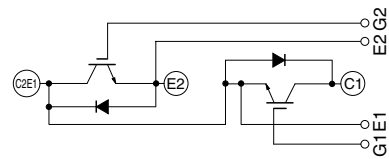
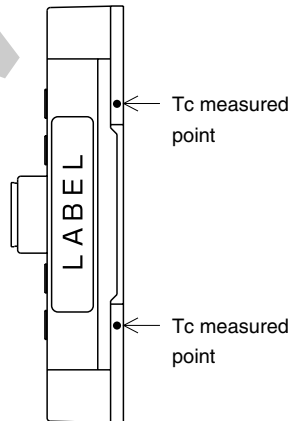
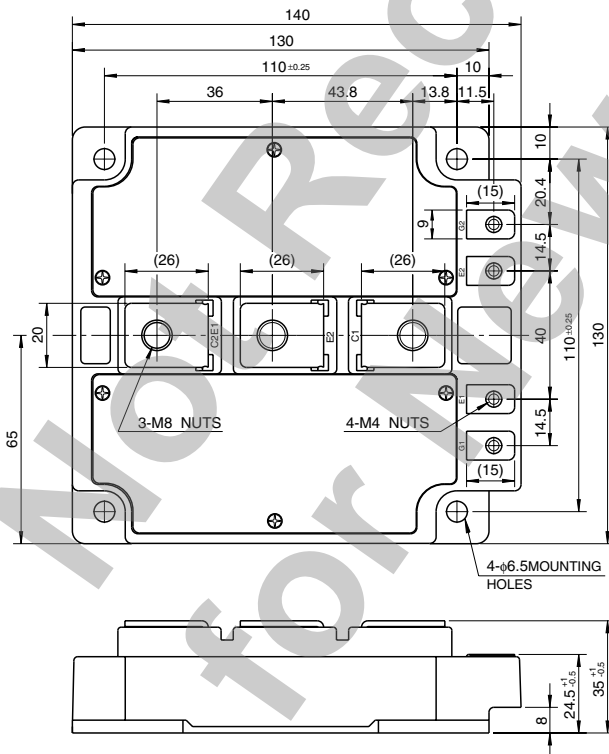
- IC300A
- VCES 1700V
- Insulated Type
- 2-elements in a pack

APPLICATION

General purpose inverters & Servo controllers, etc

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



CIRCUIT DIAGRAM

MAXIMUM RATINGS (T_j = 25°C, unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V _{CES}	Collector-emitter voltage	G-E Short	1700	V
V _{GES}	Gate-emitter voltage	C-E Short	±20	V
I _C	Collector current	T _C = 25°C	300	A
I _{CM}		Pulse (Note 2)	600	A
I _E (Note 1)	Emitter current	T _C = 25°C	300	A
I _{EM} (Note 1)		Pulse (Note 2)	600	A
P _C (Note 3)	Maximum collector dissipation	T _C = 25°C	1500	W
T _j	Junction temperature		-40 ~ +150	°C
T _{stg}	Storage temperature		-40 ~ +125	°C
V _{iso}	Isolation voltage	Terminals to base plate, f = 60Hz, AC 1 minute	3500	V _{rms}
—	Torque strength	Main terminals M8 screw	8.8 ~ 10.8	N · m
		Mounting M6 screw	3.5 ~ 4.5	
		G(E) Terminal M4 screw	1.3 ~ 1.7	
—	Weight	Typical value	1200	g

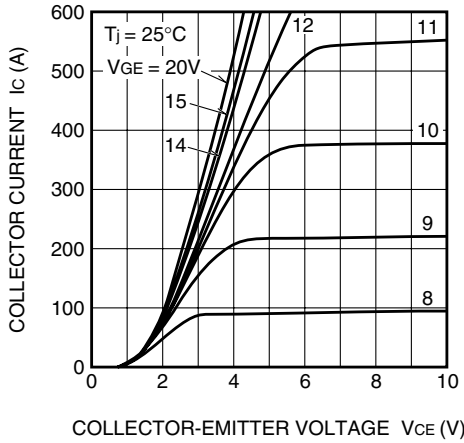
ELECTRICAL CHARACTERISTICS (T_j = 25°C, unless otherwise specified)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
I _{CES}	Collector cutoff current	V _{CE} = V _{CES} , V _{GE} = 0V	—	—	1	mA
V _{GE(th)}	Gate-emitter threshold voltage	I _C = 30mA, V _{CE} = 10V	4	5.5	7	V
I _{GES}	Gate leakage current	±V _{GE} = V _{GES} , V _{CE} = 0V	—	—	0.5	μA
V _{CE(sat)}	Collector-emitter saturation voltage	I _C = 300A, V _{GE} = 15V	T _j = 25°C		4.0	V
			T _j = 125°C		—	
C _{ies}	Input capacitance	V _{CE} = 10V V _{GE} = 0V	—	—	42	nF
C _{oes}	Output capacitance		—	—	7.2	nF
C _{res}	Reverse transfer capacitance		—	—	2.3	nF
Q _G	Total gate charge	V _{CC} = 1000V, I _C = 300A, V _{GE} = 15V	—	1350	—	nC
t _{d(on)}	Turn-on delay time	V _{CC} = 1000V, I _C = 300A V _{GE} = ±15V	—	—	800	ns
t _r	Turn-on rise time		—	—	300	ns
t _{d(off)}	Turn-off delay time		—	—	1000	ns
t _f	Turn-off fall time		—	—	800	ns
t _{rr} (Note 1)	Reverse recovery time	R _G = 3.1Ω, Inductive load I _E = 300A	—	—	600	ns
Q _{rr} (Note 1)	Reverse recovery charge		—	11.2	—	μC
V _{EC} (Note 1)	Emitter-collector voltage	I _E = 300A, V _{GE} = 0V, T _j = 25°C	—	—	4.6	V
		I _E = 300A, V _{GE} = 0V, T _j = 125°C	—	2.2	—	V
R _{th(j-c)Q}	Thermal resistance*1	IGBT part (1/2 module)	—	—	0.083	K/W
R _{th(j-c)R}		FWDi part (1/2 module)	—	—	0.13	K/W
R _{th(c-f)}	Contact thermal resistance	Case to heat sink, Thermal compound applied*2 (1/2 module)	—	0.010	—	K/W
R _{th(j-c)Q}	Thermal resistance	Case temperature measured point is just under the chips	—	—	0.035*3	K/W

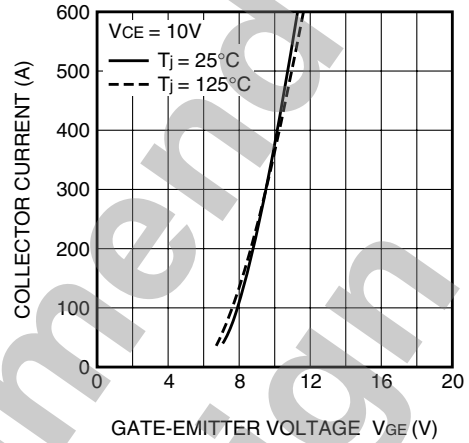
- Note 1. I_E, V_{EC}, t_{rr}, Q_{rr} & die/dt represent characteristics of the anti-parallel, emitter-collector free-wheel diode (FWDi).
 2. Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed T_{jmax} rating.
 3. Junction temperature (T_j) should not increase beyond 150°C.
 4. Pulse width and repetition rate should be such as to cause negligible temperature rise.
 *1 : Case temperature (T_c) measured point is indicated in OUTLINE DRAWING.
 *2 : Typical value is measured by using thermally conductive grease of λ = 0.9[W/(m · K)].
 *3 : If you use this value, R_{th(f-a)} should be measured just under the chips.

PERFORMANCE CURVES

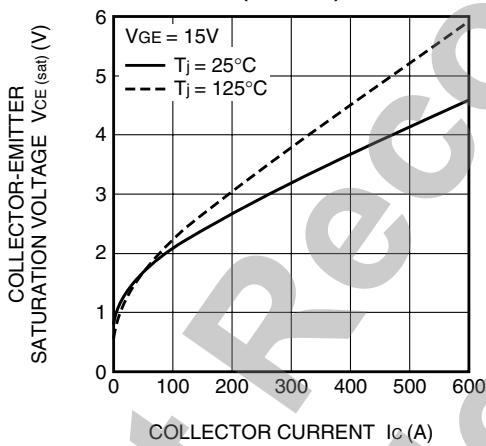
OUTPUT CHARACTERISTICS (TYPICAL)



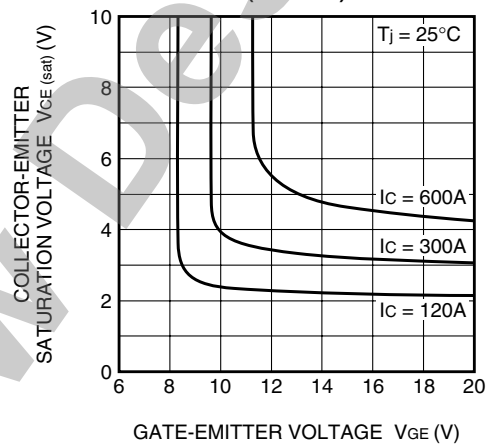
TRANSFER CHARACTERISTICS (TYPICAL)



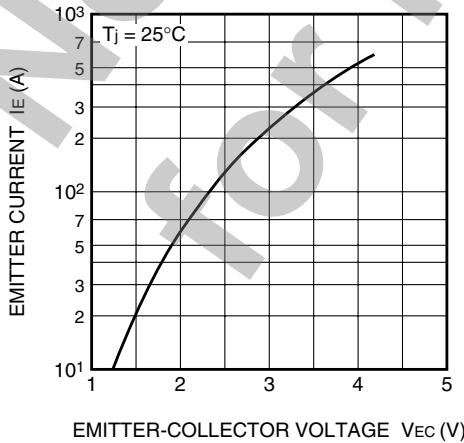
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



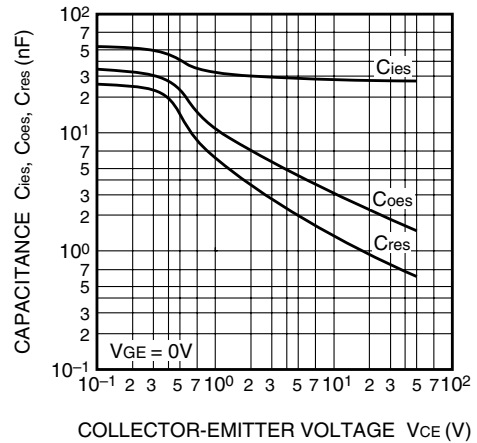
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



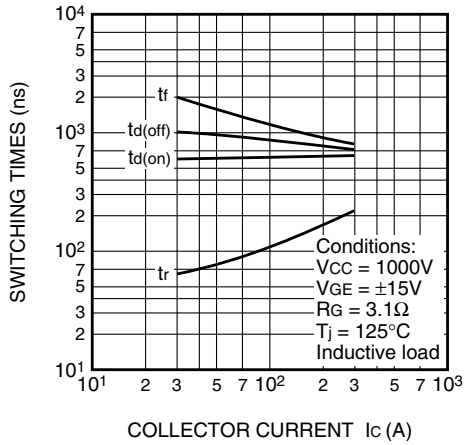
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



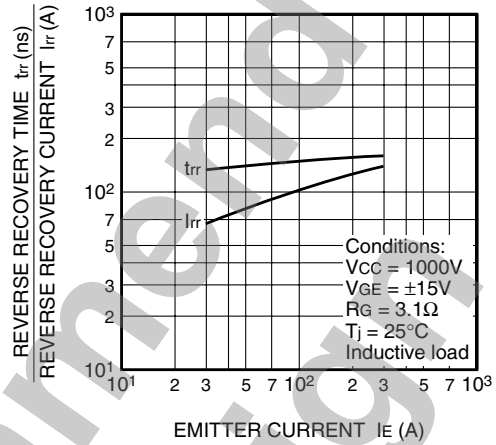
CAPACITANCE-Vce CHARACTERISTICS (TYPICAL)



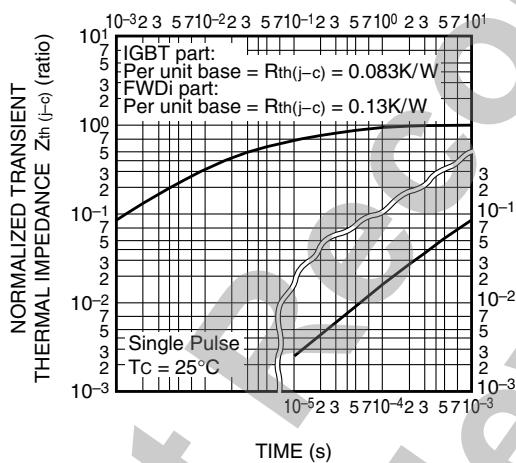
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



REVERSE RECOVERY CHARACTERISTICS OF FREE-WHEEL DIODE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (IGBT part & FWDi part)



GATE CHARGE CHARACTERISTICS (TYPICAL)

